

Selection Guide

					-	10		-15		-25	Unit
Maximum Frequency			1	00		66.7		40	MHz		
Maximum Access Time				8		10		15	ns		
Minimum C	ycle Time					10	15			25	ns
Minimum D	ata or Enable Set-	up			3		4			6	ns
Minimum Data or Enable Hold			0.5		1			1	ns		
Maximum F	lag Delay				8		10			15	ns
Active Powe	er Supply Current		Commercia	al	35		35			35	ICC1
			Industrial		4	10		40		40	
	CY7C4421	C	Y7C4201	CY7	C4211	CY7C4	221	CY7C423	1	CY7C4241	CY7C4251
Density	64 × 9	2	256 × 9	512	2×9	1K ×	9	2K × 9		4K × 9	8K × 9

Pin Definitions

Pin	Name	I/O	Description
D ₀₋₈	Data Inputs	Ι	Data Inputs for 9-bit Bus
Q ₀₋₈	Data Outputs	0	Data Outputs for 9-bit Bus
WEN1	Write Enable 1	I	The only Write enable to have programmable flags <u>when device is configured</u> . Data is written on a LOW-to-HIGH transition of WCLK when WEN1 is asserted and FF is HIGH. If the FIFO is configured to <u>have</u> two Write enables, <u>data</u> is <u>written</u> on a LOW-to-HIGH transition of WCLK when WEN1 is LOW and WEN2/LD and FF are HIGH.
	Write Enable 2	Ι	If HIGH at reset, this pin operates as a second Write enable. If LOW at reset, this pin
Mode Pin	Load	I	operates as a control to Write or Read the programmable flag offsets. WEN1 must be LOW and WEN <u>2</u> must be HIGH to write data into the FIFO. Data will not be written into the FIF <u>O if</u> the FF is LOW. If the FIFO is configured to have programmable flags, WEN2/LD is held LOW to write or read the programmable flag offsets.
REN1, REN2	Read Enable Inputs	Ι	Enables Device for Read Operation
WCLK	Write Clock	Ι	The rising edge clocks data into the FIFO when WEN1 is LOW, WEN2/LD is HIGH, and the FIFO is not Full. When LD is asserted, WCLK writes data into the programmable flag-offset register.
RCLK	Read Clock	I	The rising edge clocks data out of the FIFO when REN1 and REN2 are LOW and the FIFO is not Empty. When WEN2/LD is LOW, RCLK reads data out of the programmable flag-offset register.
EF	Empty Flag	0	When \overline{EF} is LOW, the FIFO is empty. \overline{EF} is synchronized to RCLK.
FF	Full Flag	0	When FF is LOW, the FIFO is full. FF is synchronized to WCLK.
PAE	Programmable Almost Empty	0	When PAE is LOW, the FIFO is almost empty based on the almost empty offset value programmed into the FIFO.
PAF	Programmable Almost Full	0	When PAF is LOW, the FIFO is almost full based on the almost full offset value programmed into the FIFO.
RS	Reset	I	Resets device to empty condition. A reset is required before an initial Read or Write operation after power-up.
ŌĒ	Output Enable	Ι	When \overline{OE} is LOW, the FIFO's data outputs drive the bus to which they are connected. If OE is HIGH, the FIFO's outputs are in High-Z (high-impedance) state.



Functional Description

The CY7C42X1 provides four status pins: Empty, Full, Almost Empty, Almost Full. The Almost Empty/Almost Full flags are programmable to single word granularity. The programmable flags default to Empty – 7 and Full – 7.

The flags are synchronous, i.e., they change state relative to either the Read clock (RCLK) or the Write clock (WCLK). When entering or exiting the Empty and Almost Empty states, the flags are updated exclusively by the RCLK. The flags denoting Almost Full, and Full states are updated exclusively by WCLK. The synchronous flag architecture guarantees that the flags maintain their status for at least one cycle.

All configurations are fabricated using advanced 0.65μ N-Well CMOS technology. Input ESD protection is greater than 2001V, and latch-up is prevented by the use of guard rings.

Architecture

The CY7C42X1 consists of an array of 64 to 8K words of 9 bits each (implemented by a dual-port array of SRAM cells), a <u>Read pointer, a Wri</u>te pointer, control signals (<u>RCLK, WC</u>LK, REN1, REN2, WEN1, WEN2, RS), and flags (EF, PAE, PAF, FF).

Resetting the FIFO

Upon power-up, the FIFO must be reset with a Reset (\overline{RS}) cycle. This <u>causes</u> the FIFO to enter the Empty condition signified by EF being LOW. All data outputs (Q_{0-8}) go LOW t_{RSF} after the rising edge of \overline{RS} . In order for the FIFO to reset to its default state, a falling edge m<u>ust</u> occur on \overline{RS} and the user must not read or Write while \overline{RS} is LOW. All flags are guaranteed to be valid t_{RSF} after \overline{RS} is taken LOW.

FIFO Operation

When the WEN1 signal is active LOW and WEN2 is active HIGH, data present on the D_{0-8} pins is written into the FIF<u>O</u> on each rising edge of the WCLK signal. Similarly, when the REN1 and REN2 signals are active LOW, data in the FIFO memory will be presented on the Q_{0-8} outputs. New data will be presented on each rising edge of RCLK while REN1 and REN2 are active. REN1 and REN2 must set up t_{ENS} before RCLK for it to be a valid Read function. WEN1 and WEN2 must occur t_{ENS} before WCLK for it to be a valid Write function.

An output enable ($\overline{\text{OE}}$) pin is provided to three-state the Q₀₋₈ outputs when OE is asserted. When OE is enabled (LOW), data in the output register will be available to the Q₀₋₈ outputs after t_{OE}.

The FIFO contains overflow circuitry to disallow additional writes when the FIFO is full, and underflow circuitry to disallow additional reads when the FIFO is empty. An empty FIFO

maintains the data of the last valid Read on its ${\rm Q}_{\rm 0-8}$ outputs even after additional reads occur.

Write Enable 1 (WEN1). If the <u>FIFO</u> is configured for programmable flags, Write Enable 1 (WEN1) is the only Write <u>enable</u> control pin. In this configuration, when Write Enable 1 (WEN1) is LOW, data can be loaded into the input register and RAM array on the LOW-to-HIGH transition of every Write clock (WCLK). Data is stored is the RAM array sequentially and independently of any on-going Read operation.

Write Enable 2/Load (WEN2/LD). This is a dual-purpose pin. The FIFO is configured at Reset to have programmable flags or to have two Write enables, which allows for depth expansion. If Write Enable 2/Load (WEN2/LD) is set active HIGH at Reset (RS = LOW), this pin operates as a second Write enable pin.

If the FIFO is <u>configu</u>red to have two Write enables, when Write <u>Enable</u> (WEN1) is LOW and Write Enable 2/Load (WEN2/LD) is HIGH, data can be loaded into the input register and RAM array on the LOW-to-HIGH transition of every Write clock (WCLK). Data is stored in the RAM array sequentially and independently of any on-going Read operation.

Programming

When WEN2/LD is held LOW during Reset, this pin is the load (LD) enable for flag offset programming. In this configuration, WEN2/LD can be used to access the four 8-bit offset registers contained in the CY7C42X1 for writing or reading data to these registers.

When the device is configured for programmable flags and both WEN2/LD and WEN1 are LOW, the first LOW-to-HIGH transition of WCLK writes data from the data inputs to the empty offset least significant bit (LSB) register. The second, third, and fourth LOW-to-HIGH transitions of WCLK store data in the empty offset most significant bit (MSB) register, full offset LSB register, and full offset MSB register, respectively, when WEN2/LD and WEN1 are LOW. The fifth LOW-to-HIGH transition of WCLK while WEN2/LD and WEN1 are LOW writes data to the empty LSB register again. *Figure 1* shows the registers sizes and default values for the various device types.

It is not necessary to write to all the offset registers at one time. A subset of <u>the</u> offset registers can be written; then by bringing the WEN2/LD input HIGH, the FIFO is returned to normal Read and Write operation. The next time WEN2/LD is brought LOW, a Write operation stores data in the next offset register in sequence.

The contents of the <u>offs</u>et registers can be <u>read</u> to the <u>data</u> outputs when WEN2/LD is LOW and both REN1 and REN2 are LOW. LOW-to-HIGH transitions of RCLK Read register contents to the data outputs. Writes and reads should not be preformed simultaneously on the offset registers.



CY7C4421/4201/4211/4221 CY7C4231/4241/4251

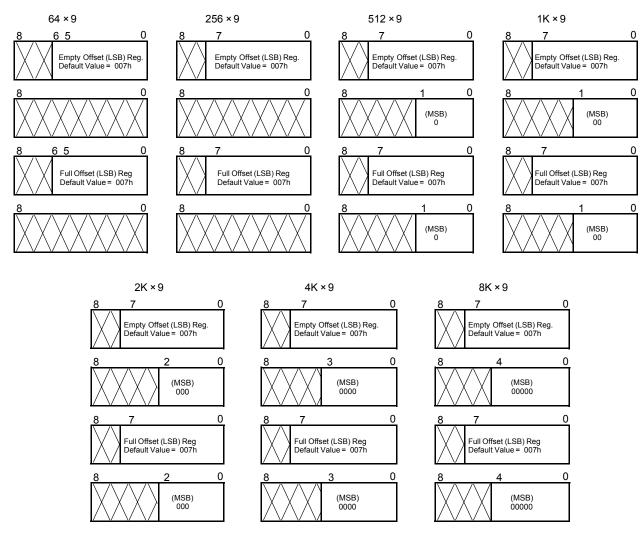


Figure 1. Offset Register Location and Default Values



CY7C4421/4201/4211/4221 CY7C4231/4241/4251

Programmable Flag (PAE, PAF) Operation

Whether the flag offset registers are programmed as described in *Table 1* or the default values are used, the programmable almost-empty flag (PAE) and programmable almost-full flag (PAF) states are determined by their corresponding offset registers and the difference between the Read and Write pointers.

The number formed by the empty offset least significant bit register and empty offset most significant register is referred to as *n* and determines the operation of PAE. PAE is synchronized to the LOW-to-HIGH transition of RCLK by one flip-flop and is LOW when the FIFO contains n or fewer unread words. PAE is set HIGH by the LOW-to-HIGH transition of RCLK when the FIFO contains (n + 1) or greater unread words.

The number formed by the full offset least significant bit register and full offset most significant bit register is referred to as *m* and determines the operation of PAF. PAE is synchronized to the LOW-to-HIGH transition of WCLK by one flip-flop and is set LOW when the number of unread words in the FIFO is greater than or equal to CY7C4421. (64 - m), CY7C4201

 $(256-m),\ CY7C4211\ (512-m),\ CY7C4221\ (1K-m),\ CY7C4231\ (2K-m),\ CY7C4231\ (4K-m),\ and\ CY7C4251\ (8K-m).\ PAF$ is set HIGH by the LOW-to-HIGH transition of WCLK when the number of available memory locations is greater than m.

Table 1. Writing the Offset Registers

LD	WEN	WCLK ^[1]	Selection
0	0		Empty Offset (LSB) Empty Offset (MSB) Full Offset (LSB) Full Offset (MSB)
0	1		No Operation
1	0		Write Into FIFO
1	1		No Operation

Table 2. Status Flags

	Number of Words in FIFO					
CY7C4421	CY7C4201	CY7C4211	FF	PAF	PAE	EF
0	0	0	Н	Н	L	L
1 to n ^[2]	1 to n ^[2]	1 to n ^[2]	Н	Н	L	Н
(n + 1) to 32	(n + 1) to 128	(n + 1) to 256	Н	Н	Н	Н
33 to (64 – (m + 1))	129 to (256 – (m + 1))	257 to (512 – (m + 1))	Н	Н	Н	Н
(64 – m) ^[3] to 63	(256 – m) ^[3] to 255	(512 – m) ^[3] to 511	Н	L	Н	Н
64	256	512	L	L	Н	Н

	Number of Words in FIFO						
CY7C4221	CY7C4231	CY7C4241	CY7C4251	FF	PAF	PAE	EF
0	0	0	0	Н	Н	L	L
1 to n ^[2]	Н	Н	L	Н			
(n + 1) to 512	(n + 1) to 1024	(n + 1) to 2048	(n + 1) to 4096	Н	Н	Н	Н
513 to (1024 – (m + 1))	1025 to (2048 – (m + 1))	2049 to (4096 – (m + 1))	4097 to (8192 – (m + 1))	Н	Н	Н	Н
(1024 – m) ^[3] to 1023	(2048 – m) ^[3] to 2047	(4096 – m) ^[3] to 4095	(8192 – m) ^[3] to 8191	Н	L	Н	Н
1024	2048	4096	8192	L	L	Н	Н

Notes:

1. The same selection sequence applies to reading from the registers. REN1 and REN2 are enabled and a Read is performed on the LOW-to-HIGH transition of RCLK.

2. n = Empty Offset (n = 7 default value).

3. m = Full Offset (m = 7 default value).



Width Expansion Configuration

Word width may be increased simply by connecting the corresponding input controls signals of multiple devices. A composite flag should be created for each of the end-point status flags (EF and FF). The partial status flags (PAE and PAF) can be detected from any one device. *Figure 2* demonstrates a 18-bit word width by using two CY7C42X1s. Any word width can be attained by adding additional CY7C42X1s.

When the CY7C42X1 is in a Width Expansion Configuration, the Read Enable ($\overline{REN2}$) control input can be grounded (See *Figure 2*). In this configuration, the Write Enable 2/Load (WEN2/LD) pin is set to LOW at Reset so that the pin operates as a control to load and read the programmable flag offsets.

Flag Operation

The CY7C42X1 devices provide four flag pins to indicate the condition of the FIFO contents. Empty, Full, PAE, and PAF are synchronous.

Full Flag

The Full Flag (FF) will go LOW when device is full. Write operations are inhibited whenever FF is LOW regardless of the state of WEN1 and WEN2/LD. FF is synchronized to WCLK, i.e., it is exclusively updated by each rising edge of WCLK.

Empty Flag

The Empty Flag (\overline{EF}) will go LOW when the device is empty. Read operations are inhibited whenever \overline{EF} is LOW, regardless of the state of REN1 and REN2. \overline{EF} is synchronized to RCLK, i.e., it is exclusively updated by each rising edge of RCLK.

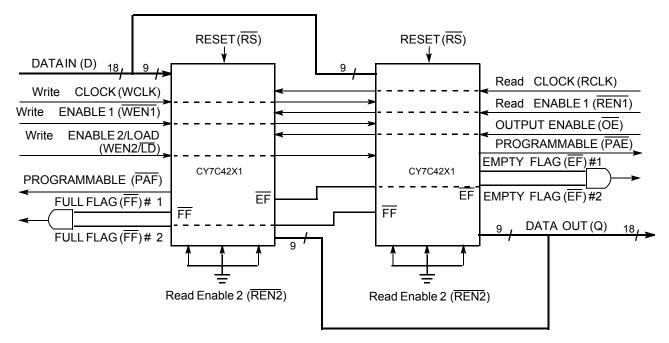


Figure 2. Block Diagram of 64 x 9, 256 x 9, 512 x 9, 1024 x 9, 2048 x 9, 4096 x 9, 8192 x 9 Synchronous FIFO Memory Used in a Width Expansion Configuration



CY7C4421/4201/4211/4221 CY7C4231/4241/4251

Maximum Ratings^[4]

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	.–65°C to +150°C
Ambient Temperature with Power Applied	.–55°C to +125°C
Supply Voltage to Ground Potential	–0.5V to +7.0V
DC Voltage Applied to Outputs	
in High-Z State	–0.5V to +7.0V
DC Input Voltage	3.0V to +7.0V

Output Current into Outputs (LOW)	20 mA
Static Discharge Voltage (per MIL-STD-883, Method 3015)	> 2001V
Latch-up Current	>200 mA

Operating Range

Range	Ambient Temperature	V _{cc}
Commercial	0°C to +70°C	5V ±10%
Industrial ^[5]	–40°C to +85°C	5V ±10%

Electrical Characteristics Over the Operating Range^[6]

		Test Conditions		-1	10	-15		-25		
Parameter	Description			Min.	Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -2.0 mA		2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA			0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage			2.2	V _{CC}	2.2	V _{CC}	2.2	V _{CC}	V
V _{IL}	Input LOW Voltage			-3.0	0.8	-3.0	0.8	-3.0	0.8	V
I _{IX}	Input Leakage Current	V _{CC} = Max.		-10	+10	-10	+10	-10	+10	μΑ
I _{OS} ^[7]	Output Short Circuit Current	V _{CC} = Max., V _{OUT} = GND		-90		-90		-90		mA
I _{OZL} I _{OZH}	Output OFF, High-Z Current	$\frac{\overline{OE} \ge V_{IH}}{V_{SS} < V_O < V_{CC}}$		-10	+10	-10	+10	-10	+10	mA
I _{CC1} ^[8]	Active Power Supply	Comm	nercial		35		35		35	mA
	Current	Indust	rial		40		40		40	mA
I _{CC2} ^[9]	Average Standby	Comm	nercial		10		10		10	mA
	Current	Indust	rial		15		15		15	mA

Capacitance^[10]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_{A} = 25^{\circ}C, f = 1 \text{ MHz},$	5	pF
C _{OUT}	Output Capacitance	V _{CC} = 5.0V	7	pF

Notes:

4. The Voltage on any input or I/O pin cannot exceed the power pin during power-up.

5. T_A is the "instant on" case temperature.

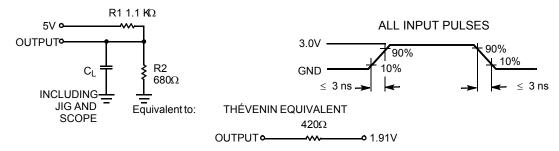
6. See the last page of this specification for Group A subgroup testing information.

7. Test no more than one output at a time for not more than one second.

8. Outputs open. Tested at Frequency = 20 MHz. 9. All inputs = V_{CC} – 0.2V, except WCLK and RCLK, which are switching at 20 MHz. 10. Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms^[11, 12]



Switching Characteristics Over the Operating Range

			10	-15		-25		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t _S	Clock Cycle Frequency		100		66.7		40	MHz
t _A	Data Access Time	2	8	2	10	2	15	ns
t _{CLK}	Clock Cycle Time	10		15		25		ns
t _{CLKH}	Clock HIGH Time	4.5		6		10		ns
t _{CLKL}	Clock LOW Time	4.5		6		10		ns
t _{DS}	Data Set-up Time	3		4		6		ns
t _{DH}	Data Hold Time	0.5		1		1		ns
t _{ENS}	Enable Set-up Time	3		4		6		ns
t _{ENH}	Enable Hold Time	0.5		1		1		ns
t _{RS}	Reset Pulse Width ^[13]	10		15		25		ns
t _{RSS}	Reset Set-up Time	8		10		15		ns
t _{RSR}	Reset Recovery Time	8		10		15		ns
t _{RSF}	Reset to Flag and Output Time		10		15		25	ns
t _{OLZ}	Output Enable to Output in Low-Z ^[14]	0		0		0		ns
t _{OE}	Output Enable to Output Valid	3	7	3	8	3	12	ns
t _{OHZ}	Output Enable to Output in High-Z ^[14]	3	7	3	8	3	12	ns
t _{WFF}	Write Clock to Full Flag		8		10		15	ns
t _{REF}	Read Clock to Empty Flag		8		10		15	ns
t _{PAF}	Clock to Programmable Almost-Full Flag		8		10		15	ns
t _{PAE}	Clock to Programmable Almost-Full Flag		8		10		15	ns
t _{SKEW1}	Skew Time between Read Clock and Write Clock for Empty Flag and Full Flag	5		6		10		ns
t _{SKEW2}	Skew Time between Read Clock and Write Clock for Almost-Empty Flag and Almost-Full Flag	10		15		18		ns

Notes:

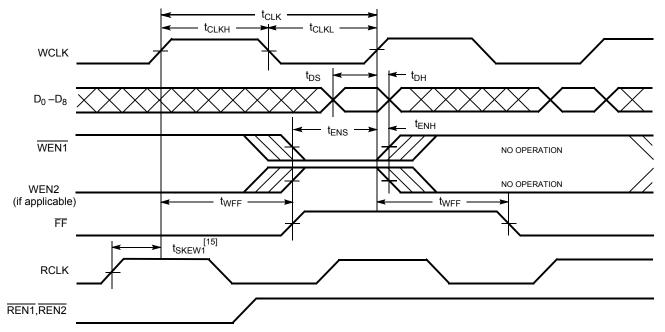
11. $C_L = 30 \text{ pF}$ for all AC parameters except for t_{OHZ} . 12. $C_L = 5 \text{ pF}$ for t_{OHZ} . 13. Pulse widths less than minimum values are not allowed.

14. Values guaranteed by design, not currently tested.

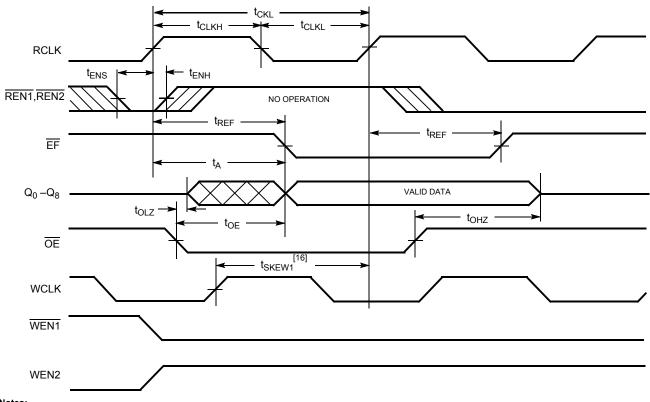


Switching Waveforms

Write Cycle Timing



Read Cycle Timing

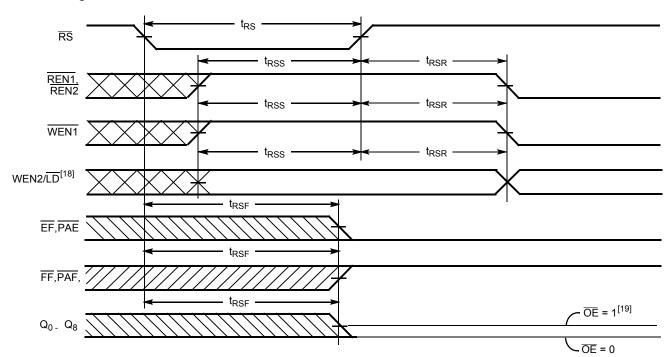


Notes:

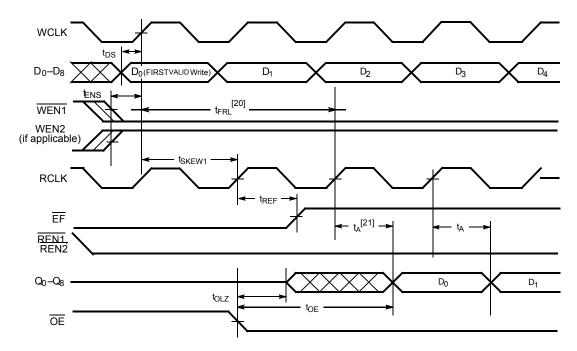
15. t_{SKEW1} is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF will go HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than t_{SKEW1}, then FF may not <u>change</u> state until the next WCLK rising edge.
 16. t_{SKEW1} is the minimum time between a rising WCLK edge and a rising RCLK edge to guarantee that EF will go HIGH during the current clock cycle. It the time between the rising edge of WCLK and the rising edge of RCLK is less than t_{SKEW1}, then EF may not change state until the next WCLK rising edge.



Reset Timing^[17]



First Data Word Latency after Reset with Simultaneous Read and Write

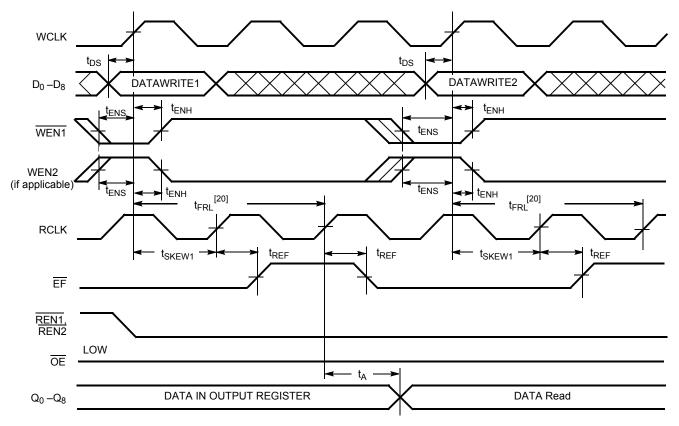


Notes:

- 17. The clocks (RCLK, WCLK) can be free-running during reset.
- 18. Holding WEN2/LD HIGH during reset will make the pin act as a second enable pin. Holding WEN2/LD LOW during reset will make the pin act as a load enable
- 18. Holding WENZ/LD Finder during reset will make the pur act as a second chable pur resting ment to any method of pur rest, the cutputs will be LOW if OE = 0 and three-state if OE = 1.
 20. When t_{SKEW1} ≥ minimum specification, t_{FRL} (maximum) = t_{CLK} + t_{SKEW1}. When t_{SKEW1} < minimum specification, t_{FRL} (maximum) = either 2*t_{CLK} + t_{SKEW1} or t_{CLK} + t_{SKEW1}. The Latency Timing applies only at the Empty Boundary (EF = LOW).
 21. The first word is available the cycle after EF goes HIGH, always.

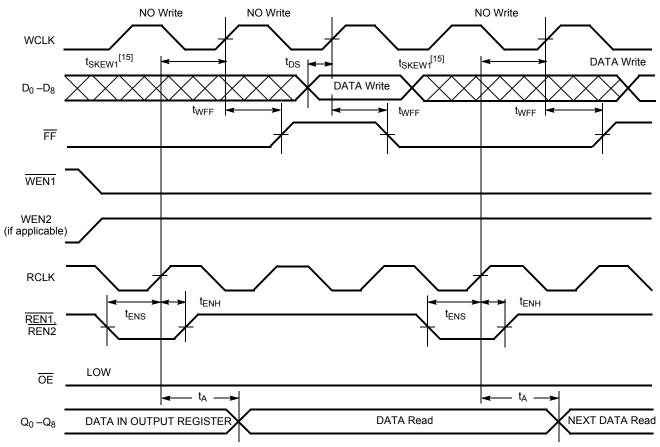


Empty Flag Timing

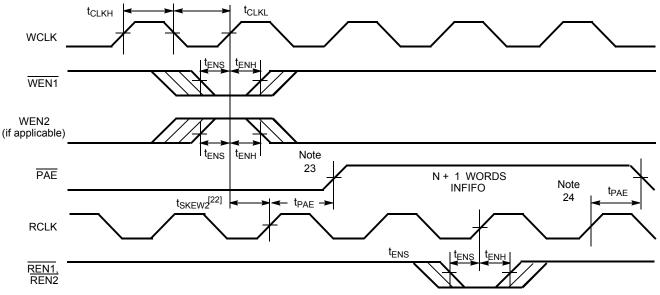




Full Flag Timing



Programmable Almost Empty Flag Timing



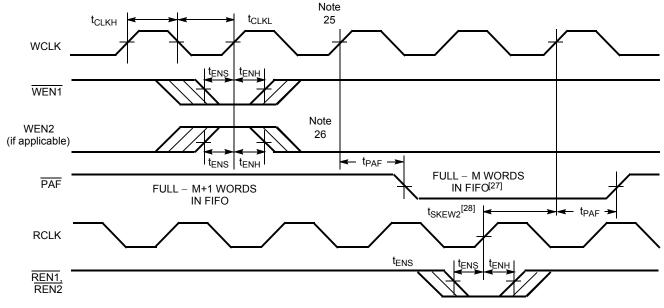
Notes:

t_{SKEW2} is the minimum time between a rising WCLK and a rising RCLK edge for PAE to change state during that clock cycle. If the time between the edge of WCLK and the rising RCLK is less than t_{SKEW2}, then PAE may not change state until the next RCLK. 22. 23. PAE offset = n.

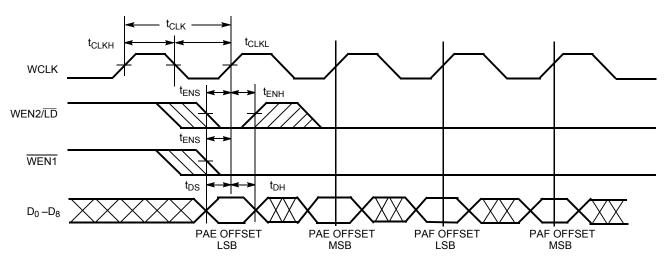
24. If a Read is performed on this rising edge of the Read clock, there will be Empty + (n – 1) words in the FIFO when PAE goes LOW.



Programmable Almost Full Flag Timing



Write Programmable Registers



Notes:

25. If a Write is performed on this rising edge of the Write clock, there will be Full – (m - 1) words of the FIFO when PAF goes LOW.

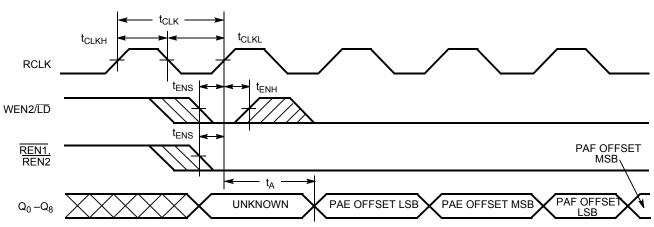
26. PAF offset = m.

27. 64-m words for CY7C4421, 256 – m words in FIFO for CY7C4201, 512 – m words for CY7C4211, 1024 – m words for CY7C4221, 2048 – m words for CY7C4221, 4096 – m words for CY7C4241, 8192 – m words for CY7C4251.

28. t_{SKEW2} is the minimum time between a rising RCLK edge and a rising WCLK edge for PAF to change during that clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than t_{SKEW2}, then PAF may not change state until the next WCLK.

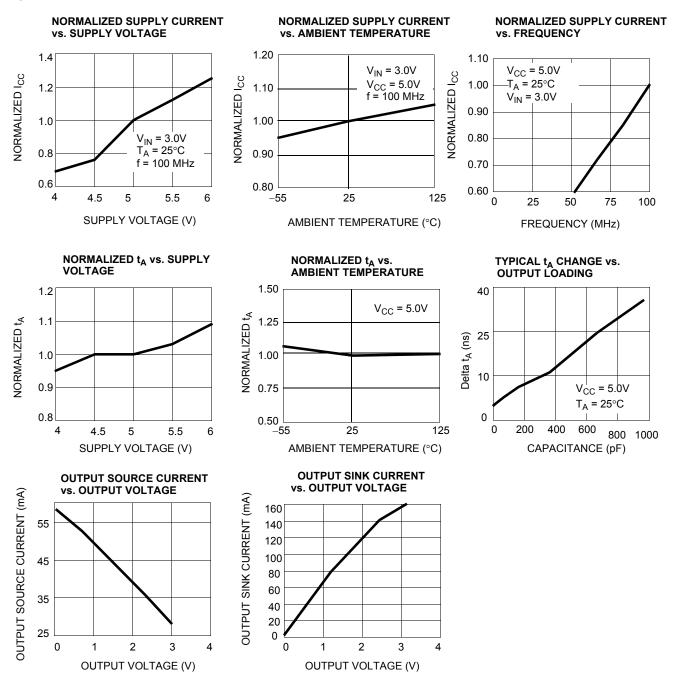


Read Programmable Registers





Typical AC and DC Characteristics





Ordering Information

64 x 9 Synchronous FIFO

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4421-10AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4421-10JC	J65	32-lead Plastic Leaded Chip Carrier	
	CY7C4421-10JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	
15	CY7C4421-15AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4421-15JC	J65	32-lead Plastic Leaded Chip Carrier	1

256 x 9 Synchronous FIFO

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4201-10AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4201-10JC	J65	32-lead Plastic Leaded Chip Carrier	
15	CY7C4201-15AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4201-15AXC	A32	32-lead Pb-Free Thin Quad Flatpack	
	CY7C4201-15JC	J65	32-lead Plastic Leaded Chip Carrier	
	CY7C4201-15JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	
25	CY7C4201-25AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4201-25JC	J65	32-lead Plastic Leaded Chip Carrier	
	CY7C4201-25AI	A32	32-lead Thin Quad Flatpack	Industrial

512 x 9 Synchronous FIFO

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4211-10AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4211-10JC	J65	32-lead Plastic Leaded Chip Carrier	
	CY7C4211-10AI	A32	32-lead Thin Quad Flatpack	Industrial
	CY7C4211-10AXI	A32	32-lead Pb-Free Thin Quad Flatpack	
	CY7C4211-10JI	J65	32-lead Plastic Leaded Chip Carrier	
15	CY7C4211-15AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4211-15AXC	A32	32-lead Pb-Free Thin Quad Flatpack	
	CY7C4211-15JC	J65	32-lead Plastic Leaded Chip Carrier	
	CY7C4211-15JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	
	CY7C4211-15AI	A32	32-lead Thin Quad Flatpack	Industrial
25	CY7C4211-25AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4211-25JC	J65	32-lead Plastic Leaded Chip Carrier	7

1K x 9 Synchronous FIFO

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4221-10AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4221-10JC	J65	32-lead Plastic Leaded Chip Carrier	
15	CY7C4221-15AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4221-15AXC	A32	32-lead Pb-Free Thin Quad Flatpack	
	CY7C4221-15JC	J65	32-lead Plastic Leaded Chip Carrier	
	CY7C4221-15JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	
25	CY7C4221-25AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4221-25JC	J65	32-lead Plastic Leaded Chip Carrier	1

Document #: 38-06016 Rev. *C



2K x 9 Synchronous FIFO

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4231-10AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4231-10JC	J65	32-lead Plastic Leaded Chip Carrier	
15	CY7C4231-15AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4231-15AXC	A32	32-lead Pb-Free Thin Quad Flatpack	_
	CY7C4231-15JC	J65	32-lead Plastic Leaded Chip Carrier	_
	CY7C4231-15JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	-
25	CY7C4231-25AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4231-25JC	J65	32-lead Plastic Leaded Chip Carrier	1

4K x 9 Synchronous FIFO

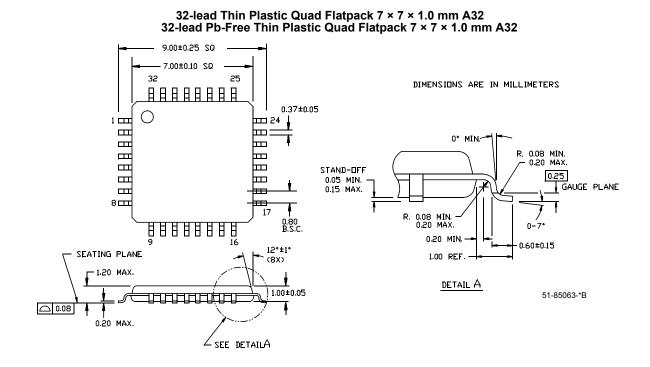
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4241-10AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4241-10AXC	A32	32-lead Pb-Free Thin Quad Flatpack	
	CY7C4241-10JC	J65	32-lead Plastic Leaded Chip Carrier	
	CY7C4241-10JI	J65	32-lead Plastic Leaded Chip Carrier	Industrial
15	CY7C4241-15AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4241-15AXC	A32	32-lead Pb-Free Thin Quad Flatpack	-
	CY7C4241-15JC	J65	32-lead Plastic Leaded Chip Carrier	-
	CY7C4241-15JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	-
25	CY7C4241-25AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4241-25JC	J65	32-lead Plastic Leaded Chip Carrier	-
	CY7C4241-25JI	J65	32-lead Plastic Leaded Chip Carrier	Industrial

8K x 9 Synchronous FIFO

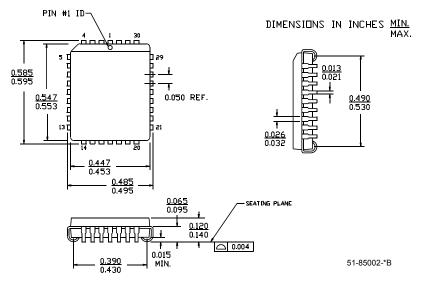
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C4251-10AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4251-10JC	J65	32-lead Plastic Leaded Chip Carrier	-
	CY7C4251-10JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	-
	CY7C4251-10AI	A32	32-lead Thin Quad Flatpack	Industrial
	CY7C4251-10AXI	A32	32-lead Pb-Free Thin Quad Flatpack	-
15	CY7C4251-15AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4251-15AXC	A32	32-lead Pb-Free Thin Quad Flatpack	-
	CY7C4251-15JC	J65	32-lead Plastic Leaded Chip Carrier	-
	CY7C4251-15JXC	J65	32-lead Pb-Free Plastic Leaded Chip Carrier	-
25	CY7C4251-25AC	A32	32-lead Thin Quad Flatpack	Commercial
	CY7C4251-25JC	J65	32-lead Plastic Leaded Chip Carrier	1
	CY7C4251-25AI	A32	32-lead Thin Quad Flatpack	Industrial



Package Diagrams



32-Lead Pb-Free Plastic Leaded Chip Carrier J65 32-Lead Plastic Leaded Chip Carrier J65



All product and company names mentioned in this document may be the trademarks of their respective holders.

Document #: 38-06016 Rev. *C

© Cypress Semiconductor Corporation, 2005. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress product. Nor does it convey or imply any license under patent or other rights. Cypress products are not warranted nor intended to be used for medical, life support, life saving, critical control or safety applications, unless pursuant to an express written agreement with Cypress. Furthermore, Cypress does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress against all charges. Downloaded from Arrow.com.



Document Title: CY7C4421/4201/4211/4221, CY7C4231/4241/4251 64/256/512/1K/2K/4K/8K x 9 Synchronous FIFOs
Document Number: 38-06016

REV.	ECN NO.	lssue Date	Orig. of Change	Description of Change
**	106477	09/10/01	SZV	Change from Spec number: 38-00419 to 38-06016
*A	110725	03/20/02	FSG	Change Input Leakage current I_{IX} unit from mA to μA (typo)
*В	122268	12/26/02	RBI	Power up requirements added to Maximum Ratings Information
*C	386306	See ECN	ESH	Added Pb-Free logo to top of front page Added CY7C4421-10JXC, CY7C4201-15AXC. CY7C4201-15JXC, CY7C4211-10AXI, CY7C4211-15AXC, CY7C4211-15JXC, CY7C4221-15AXC, CY7C4221-15JXC, CY7C4231-15JXC, CY7C4231-15AXC, CY7C4241-10AXC, CY7C4241-15AXC, CY7C4241-15JXC, CY7C4251-10JXC, CY7C4251-10AXI, CY7C4251-15AXC, CY7C4251-15JXC